

# Thermal conductive paste GD460, 1g

Reference: AM9152

EAN13: -

UPC: 38249996

## Product attributes:

## Product features:

Color: Silver

Max. operating temperature: 200°C

Thermal conductivity: 2.0W/mK



## Product description:

High quality heat conductive paste for heat sinks with thermal conductivity up to 2.0W/mK. The thermal paste is designed to ensure better heat transfer between the heat source - electronic component and its heat sink. It fills the unevenness between the surface of the heat sink and the surface of the cooled component and thus increases the heat transfer to the heat sink, which then has greater cooling efficiency. By using a heat conductive paste, you will improve the overall cooling efficiency and extend the life of the cooled components. Suitable for all semiconductors (LEDs), processors, graphics cards, memory modules and more. The paste is not electrically conductive.

Thermal conductivity: 2.0W/mK

Minimum operating temperature: -50°C

Maximum operating temperature: 200°C

Specific gravity:

